

1C971 U.S. PRO
09/013240
03/20/01

Class	Subclass	ISSUE CLASSIFICATION

PATENT NUMBER

U.S. UTILITY Patent Application

TD O.I.P.E.
SCANNED AC⁴ Q.A. AC₃

APPLICATION NO. 09/813240 CONT/PRIOR F CLASS 257 SUBCLASS 1 ART UNIT 2811 EXAMINER [Signature]

Wilfried Armer
Rudiger Schmalke
Erich Daub
Christoph Frey

Semiconductor wafer made from silicon and method for producing the semiconductor wafer

PTO-2040
12/89

ISSUING CLASSIFICATION

TERMINAL DISCLAIMER	DRAWINGS			CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
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<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____ _____				ISSUE FEE	
				Amount Due	Date Paid
<input type="checkbox"/> The terminal _____ months of this patent have been disclaimed.				ISSUE BATCH NUMBER	
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